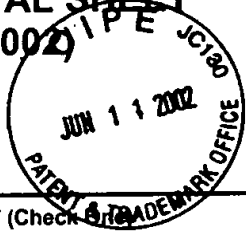


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**FEE TRANSMITTAL SHEET**  
(FOR FY 2002)



Complete If Known

Application No. **09/652,968**  
Filing Date **August 31, 2000**  
First Named Inventor **Vishnu K. Agarwal**  
Group Art Unit **2815**  
Examiner **Jose R. Diaz**  
Atty. Docket Number **501082.13 (98-0616.12)**

METHOD OF PAYMENT (Check one)

1. ☒ The Commissioner is hereby authorized to charge any additional fee required under 37 C.F.R. §§ 1.16 and 1.17 and 1.136(a)(3) and credit any over payments to Deposit Account No.: 50-1266; Deposit Account Name: DORSEY & WHITNEY LLP

2. ☐ Check Enclosed

**FEE CALCULATION**

**1. BASIC FILING FEE**

Large Entity	Small Entity	Fee Code	Fee (\$)	Fee Code	Fee (\$)	Fee Description
101	201	740	370	<input type="checkbox"/>	Utility Filing Fee	
106	206	330	165	<input type="checkbox"/>	Design Filing Fee	
108	208	740	370	<input type="checkbox"/>	Reissue Filing Fee	
114	214	160	80	<input type="checkbox"/>	Provisional Filing Fee	

Subtotal (1) **\$0**

**2. EXTRA CLAIM FEES**

Current Claims	Prior	Extra	Fee	Fee Paid
Total	7	20	= 0 x \$	= \$0
Ind.	4	4	= 0 x \$	= \$0
Multiple Dependent Claims			x \$	= \$
Subtotal (2)				<b>\$0</b>

Large Entity	Small Entity	Fee Code	Fee (\$)	Fee Code	Fee (\$)	Fee Description
103	203	18	9			Claims in excess of 20
102	202	84	42			Independent claims in excess of 3
104	204	280	140			Multiple dependent Claim
109	209	84	42			Reissue independent claims over original patent
110	210	18	9			Reissue claims in excess of 20 and over original patent

**FEE CALCULATION (Continued)**

**3. ADDITIONAL FEES**

Large Entity	Small Entity	Fee Code	Fee (\$)	Fee Code	Fee (\$)	Fee Description	Fee paid
105	205	130	65			Surcharge - Late filing fee or oath	\$
127	227	50	25			Surcharge - late provisional filing fee or cover sheet	\$
139	139	130	130			Non-English specification	\$
147	147	2,520	2,520			For Filing a Request for Reexamination	\$
195	196	300	300			Publication (early or Republication)	\$
115	215	110	55			Extension for reply within first month	\$
116	216	400	200			Extension for reply within 2 <sup>nd</sup> month	\$
117	217	920	460			Extension for reply within 3 <sup>rd</sup> month	\$
118	218	1,440	720			Extension for reply within 4 <sup>th</sup> month	\$
128	280	1,960	980			Extension for reply within 5 <sup>th</sup> month	\$
120	220	320	160			Filing a brief in support of an appeal	\$
121	270	280	140			Request for oral hearing	\$
148	248	110	55			Terminal Disclaimer Fee	\$
140	240	110	55			Petition to revive - unavoidable	\$
141	241	1,280	640			Petition to revive - unintentional	\$
142	242	1,280	640			Utility/Reissue issue fee (+ advance copies)	\$
143	243	460	230			Design issue fee (+ advance copies)	\$
122	122	130	130			Petitions to the Commissioner	\$
123	123	50	50			Petitions related to provisional applications	\$
126	126	180	180			Submission of IDS	\$
581	81	40	40			Recording each patent assignment per property (times number of properties)	\$
179	279	740	370			Request for Continued Examination (RCE)	\$

Other fee (specify)

Subtotal (3) **\$0**

Total Amount of Payment: **\$0**

Submitted by:

Name: Paul F. Rusyn

Reg. No.: 42,118

Telephone: (206) 903-8800

Signature:

Date:



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PATENT

I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to Box Non-Fee Amendment, Commissioner of Patents, Washington, DC 20231.

June 4, 2002  
Date

Ayesha S. Wilks  
Ayesha S. Wilks

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Vishnu K. Agarwal

Attorney Docket No.: 501082.13 (98-0616.12)

Serial No. : 09/652,968 ✓

Group Art Unit : 2815

Filed : August 31, 2000 ✓

Examiner : Jose R. Diaz

Title : DEVICE AND METHOD FOR PROTECTING AGAINST OXIDATION OF A  
CONDUCTIVE LAYER IN SAID DEVICE

Box Non-Fee Amendment  
Commissioner of Patents  
Washington, DC 20231

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JUN 17 2002  
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AMENDMENT

Sir:

Please amend the above-captioned patent application as follows:

In the Specification:

Please replace the paragraph beginning at page 8, line 4, with the following rewritten paragraph:

--Still other gases include diborane ( $B_2H_6$ ); phosphine ( $PH_3$ ); and carbon-silicon compounds such as methylsilane ( $CH_3SiH_3$ ) and hexamethyldisilane ( $(CH_3)_3Si-Si(CH_3)_3$ ); and hexamethyldisilazane (HMDS). Additional alternate embodiments of the current invention use hydrazine ( $N_2H_4$ ), monomethylhydrazine, carbon tetrafluoride ( $CF_4$ ),  $CHF_3$ ,  $HCl$ , and boron trichloride ( $BCl_3$ ), which are also useful in passivating dielectrics, as addressed in copending application 09/114,847, now issued as U.S. Patent No. 6,201,276 B1. Also included are mixtures of any of the gases or types of gases described above. Exemplary non-plasma process parameters using these other gases include a flow rate of about 2 sccm to about 400 sccm for